

ACJT16 Series 16A TRIACs

Rev.4.0

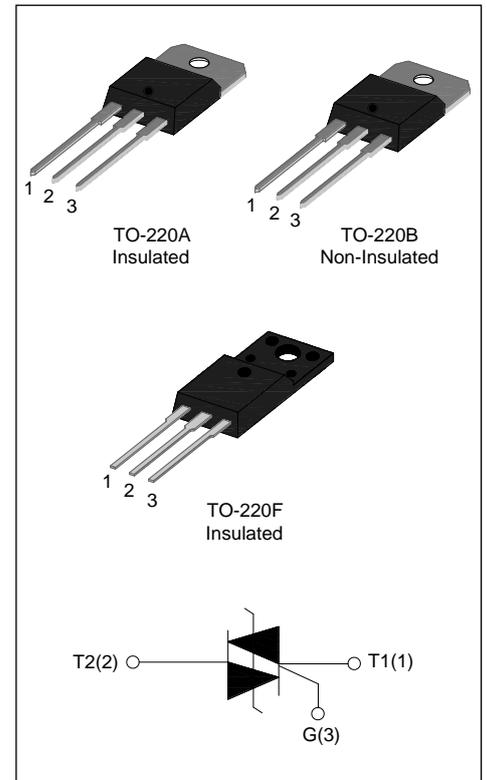
DESCRIPTION:

The ACJT16 series of double mesa technology provide high interference immunity, They can be used as an static ON/OFF function in electrical control system, and used as a driver of low power and high inductance or resistive loads, such as jet pumps of dishwashers, fans of air-conditioner ...

ACJT16xx-xxA provides insulation voltage rated at 2500V RMS and ACJT16xx-xxF provides insulation voltage rated at 2000V RMS from all three terminals to external heatsink.

MAIN FEATURES

Symbol	Value	Unit
$I_{T(RMS)}$	16	A
V_{DRM}/V_{RRM}	1000	V
I_{GT}	≤10 or ≤35 or ≤50	mA


ABSOLUTE MAXIMUM RATINGS

Parameter		Symbol	Value	Unit
Storage junction temperature range		T_{stg}	-40-150	°C
Operating junction temperature range		T_j	-40-125	°C
Repetitive peak off-state voltage($T_j=25^{\circ}C$)		V_{DRM}	1000	V
Repetitive peak reverse voltage($T_j=25^{\circ}C$)		V_{RRM}	1000	V
Non repetitive surge peak Off-state voltage		V_{DSM}	$V_{DRM} + 100$	V
Non repetitive peak reverse voltage		V_{RSM}	$V_{RRM} + 100$	V
RMS on-state current	TO-220A(Ins)/ TO-220F(Ins) ($T_C=92^{\circ}C$)	$I_{T(RMS)}$	16	A
	TO-220B(Non-Ins) ($T_C=103^{\circ}C$)			
Non repetitive surge peak on-state current (full cycle, $F=50Hz$)		I_{TSM}	160	A
I^2t value for fusing ($t_p=10ms$)		I^2t	128	A^2s
Rate of rise of on-state current ($I_G=2 \times I_{GT}$)		di_T/dt	50	A/ μs

Peak gate current	I_{GM}	4	A
Average gate power dissipation	$P_{G(AV)}$	1	W
Peak gate power	P_{GM}	5	W

ELECTRICAL CHARACTERISTICS ($T_j=25^\circ\text{C}$ unless otherwise specified)

Symbol	Test Condition	Quadrant		Value			Unit
				ACJT1610	ACJT1635	ACJT1650	
I_{GT}	$V_D=12\text{V } R_L=33\Omega$	I - II -III	MAX	10	35	50	mA
V_{GT}		I - II -III	MAX	1.5			V
V_{GD}	$V_D=V_{DRM} T_j=125^\circ\text{C}$ $R_L=3.3\text{K}\Omega$	I - II -III	MIN	0.2			V
I_L	$I_G=1.2I_{GT}$	I -III	MAX	20	60	70	mA
		II		35	70	100	
I_H	$I_T=100\text{mA}$		MAX	20	50	60	mA
dV/dt	$V_D=2/3V_{DRM}$ Gate Open $T_j=125^\circ\text{C}$		MIN	1000	1500	2000	V/ μs

STATIC CHARACTERISTICS

Symbol	Parameter		Value(MAX)	Unit
V_{TM}	$I_{TM}=22.5\text{A } t_p=380\mu\text{s}$	$T_j=25^\circ\text{C}$	1.65	V
I_{DRM}	$V_D=V_{DRM} V_R=V_{RRM}$	$T_j=25^\circ\text{C}$	10	μA
I_{RRM}		$T_j=125^\circ\text{C}$	4	mA

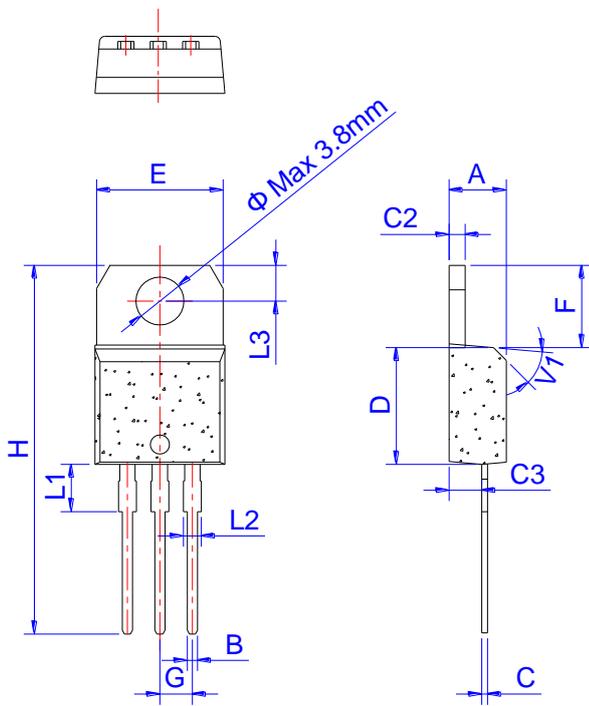
THERMAL RESISTANCES

Symbol	Parameter		Value	Unit
$R_{th(j-c)}$	junction to case(AC)	TO-220A(Ins)	2.5	$^\circ\text{C/W}$
		TO-220B(Non-Ins)	1.7	
		TO-220F(Ins)	2.7	

ORDERING INFORMATION

<p>AC</p> <p>AC switch</p> <p>JieJie Microelectronics Co.,Ltd</p>	<p>J</p>	<p>T</p> <p>Triacs</p> <p>$I_{T(RMS)}:16A$</p>	<p>16</p>	<p>35</p> <p>10: $I_{GT1-3} \leq 10mA$ 35: $I_{GT1-3} \leq 35mA$ 50: $I_{GT1-3} \leq 50mA$</p>	<p>-10</p> <p>10: $V_{DRM} / V_{RRM} \geq 1000V$</p>	<p>F</p> <p>A: TO-220A(Ins) F: TO-220F(Ins) B: TO-220B(Non-Ins)</p>
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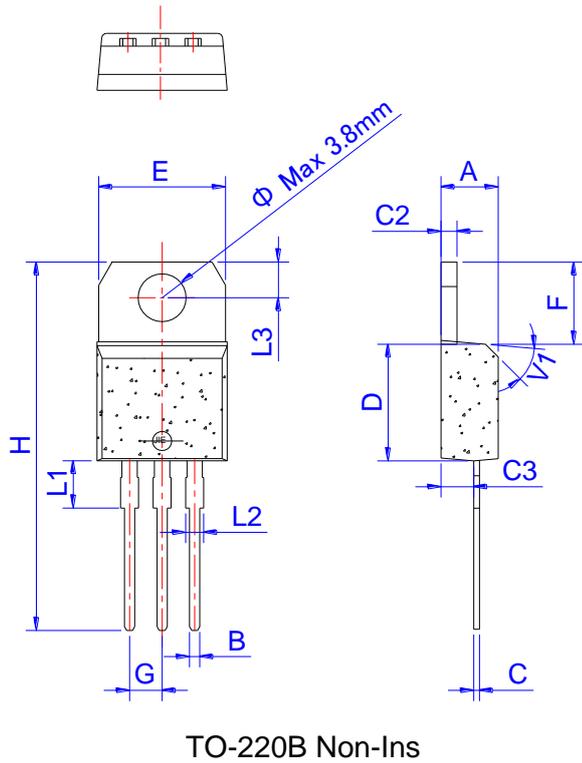
PACKAGE MECHANICAL DATA



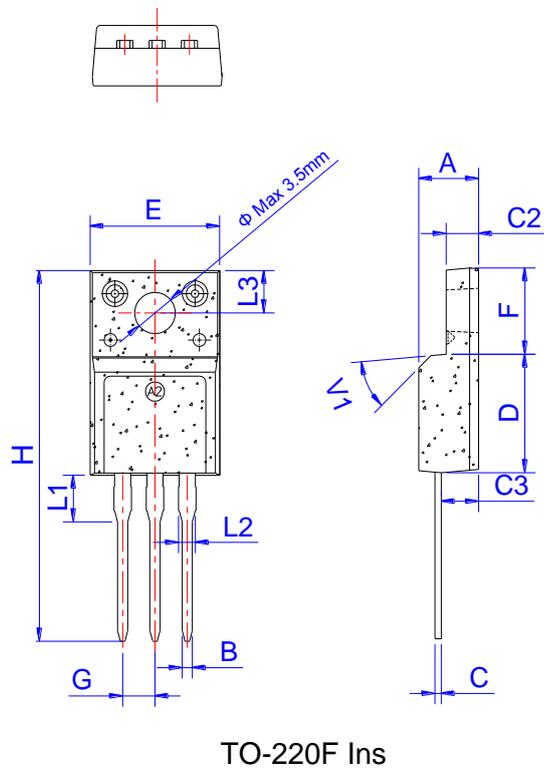
TO-220A Ins

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.40		4.60	0.173		0.181
B	0.61		0.88	0.024		0.035
C	0.46		0.70	0.018		0.028
C2	1.21		1.32	0.048		0.052
C3	2.40		2.72	0.094		0.107
D	8.60		9.70	0.339		0.382
E	9.80		10.4	0.386		0.409
F	6.55		6.95	0.258		0.274
G		2.54			0.1	
H	28.0		29.8	1.102		1.173
L1		3.75			0.148	
L2	1.14		1.70	0.045		0.067
L3	2.65		2.95	0.104		0.116
V1		45°			45°	

PACKAGE MECHANICAL DATA



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A	4.40		4.60	0.173		0.181
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C	0.46		0.70	0.018		0.028
C2	1.21		1.32	0.048		0.052
C3	2.40		2.72	0.094		0.107
D	8.60		9.70	0.339		0.382
E	9.60		10.4	0.378		0.409
F	6.20		6.60	0.244		0.260
G		2.54			0.1	
H	28.0		29.8	1.102		1.173
L1		3.75			0.148	
L2	1.14		1.70	0.045		0.067
L3	2.65		2.95	0.104		0.116
V1		45°			45°	



Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.50		4.90	0.177		0.193
B	0.74	0.80	0.83	0.029	0.031	0.033
C	0.47		0.65	0.019		0.026
C2	2.45		2.75	0.096		0.108
C3	2.60		3.00	0.102		0.118
D	8.80		9.30	0.346		0.366
E	9.80		10.4	0.386		0.410
F	6.40		6.80	0.252		0.268
G		2.54			0.1	
H	28.0		29.8	1.102		1.173
L1		3.63			0.143	
L2	1.14		1.70	0.045		0.067
L3		3.30			0.130	
V1		45°			45°	

FIG.1 Maximum power dissipation versus RMS on-state current

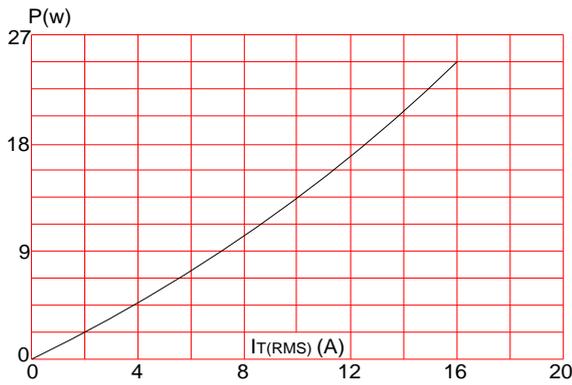


FIG.3: Surge peak on-state current versus number of cycles

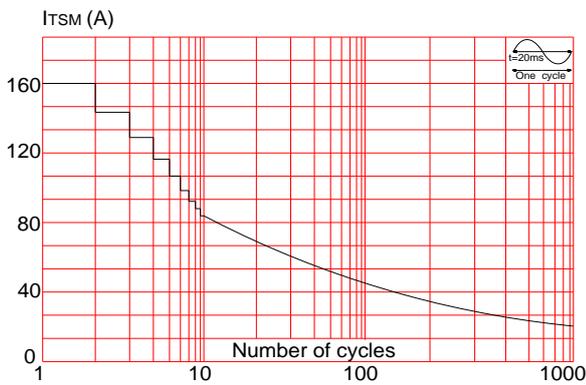


FIG.5: Relative variations of gate trigger current versus junction temperature

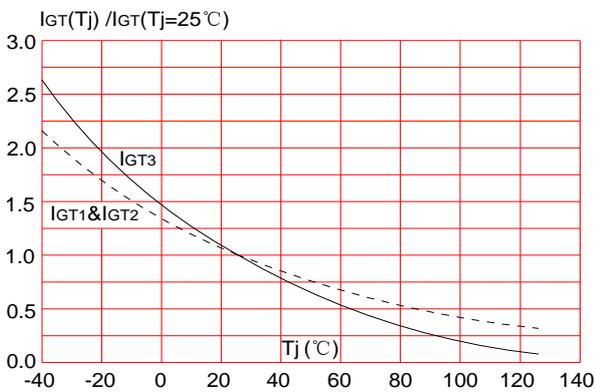


FIG.2: RMS on-state current versus case temperature

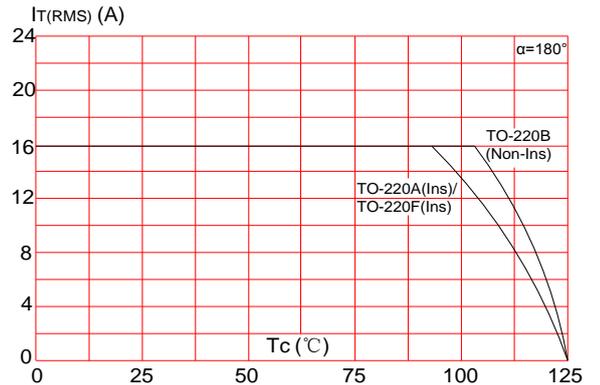


FIG.4: On-state characteristics (maximum values)

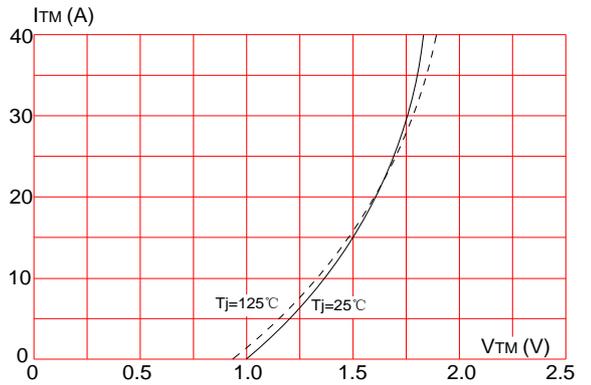
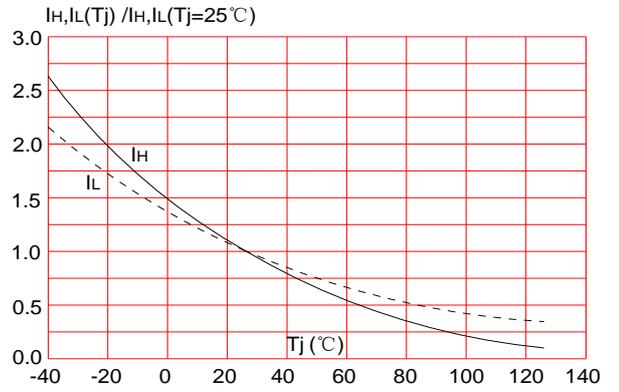


FIG.6: Relative variations of holding current, latching current versus junction temperature



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